

STPS3L60-Y

Automotive power Schottky rectifier

Features

- Negligible switching losses
- Low thermal resistance
- Avalanche capability specified
- AEC Q101 qualified
- ECOPACK®2 compliant component

Description

Schottky rectifier suited for switched mode power supplies and high frequency DC to DC converters.

Packaged in SMC this device is intended for use in DC/DC chargers for automotive applications.



Table 1. Device summary

I _{F(AV)}	3 A
V _{RRM}	60 V
T _{j (max)}	150 °C
V _{F (max)}	0.65 V

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Characteristics STPS3L60-Y

Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Paramet	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		60	V
I _{F(RMS)}	Forward rms current		10	Α
I _{F(AV)}	Average forward current $T_C = 100 ^{\circ}\text{C} \delta = 0.5$		3	Α
I _{FSM}			75	А
I _{RRM}	Repetitive peak reverse current t _p = 2 μs square F=1 kHz		1	Α
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \mu s T_j = 25 ^{\circ}C$		1600	W
T _{stg}	Storage temperature range	-65 to +175	°C	
T _j	Operating junction temperature range ⁽¹⁾		-40 to +150	°C
dV/dt	Critical rate of rise reverse voltage		10000	V/µs

^{1.} $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistances

Symbol	Parameter	Value	Unit
R _{th (j-l)}	Junction to leads	20	° C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}			55	μΑ	
'R`´	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	VR = VRRM		10	15	mA
	V _F ⁽¹⁾ Forward voltage drop	T _j = 25 °C	I _F = 3 A			0.7	
V _E ⁽¹⁾		T _j = 125 °C	I _F = 3 A		0.56	0.65	V
v F V T Of ward voltage drop	T _j = 25 °C	I _F = 6 A			0.94	V	
		T _j = 125 °C	I _F = 6 A		0.67	0.76	

^{1.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

To evaluate the conduction losses use the following equation: P = 0.54 x $I_{F(AV)}$ + 0.037x $I_{F}^{2}_{(RMS)}$

$$P = 0.54 \text{ x } I_{F(AV)} + 0.037 \text{x } I_{F}^{2}_{(BMS)}$$

STPS3L60-Y Characteristics

Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature (δ = 0.5)

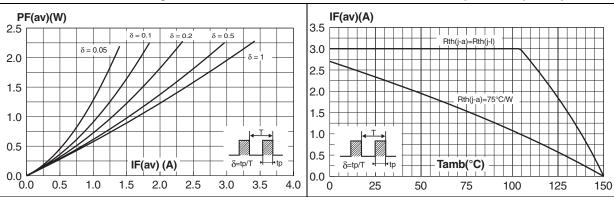


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

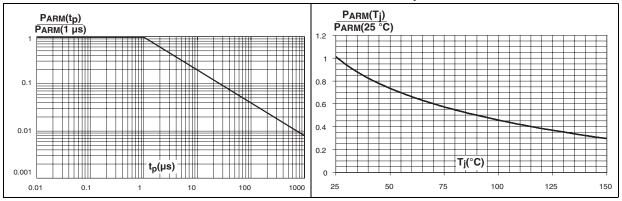
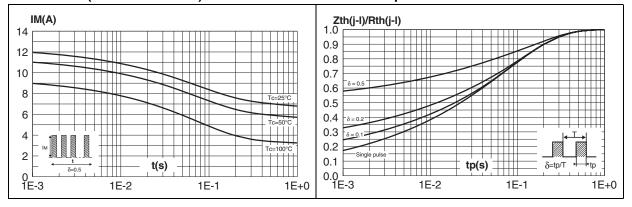


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

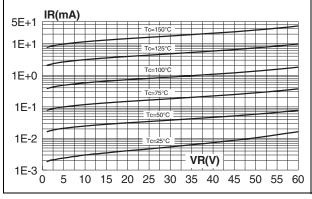
Figure 6. Relative variation of thermal impedance junction to lead versus pulse duration



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Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

Figure 8. Junction capacitance versus reverse voltage applied (typical values)



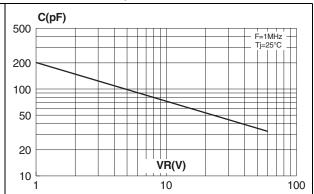
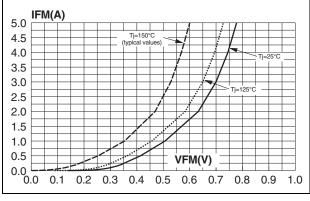


Figure 9. Forward voltage drop versus forward current (low level, maximum values)

Figure 10. Forward voltage drop versus forward current (high level, maximum values)



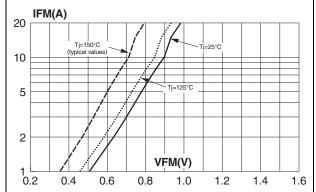
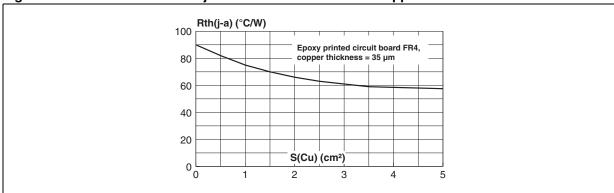


Figure 11. Thermal resistance junction to ambient versus copper surface under each lead



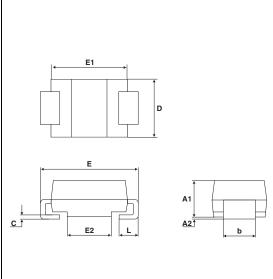
STPS3L60-Y Package information

2 Package information

- Epoxy meets UL94,V0
- Lead-free package

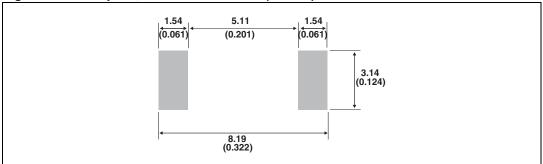
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Table 5. SMC Dimensions



	Dimensions			
Ref.	Millimeters		Inc	hes
Min.		Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b ⁽¹⁾	2.90	3.20	0.114	0.126
c ⁽¹⁾	0.15	0.40	0.006	0.016
D	5.55	6.25	0.218	0.246
Е	7.75	8.15	0.305	0.321
E1	6.60	7.15	0.260	0.281
E2	4.40	4.70	0.173	0.185
L	0.75	1.50	0.030	0.059

Figure 12. Footprint, dimensions in mm (inches)



^{1.} Dimensions b and c apply to plated leads

Ordering information STPS3L60-Y

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS3L60SY	S36Y	SMC	0.24 g	2500	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
15-Sep-2011	1	Initial release.

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